



# 74LVT574, 74LVTH574 Low Voltage Octal D-Type Flip-Flop with 3-STATE Outputs

# Features

- Input and output interface capability to systems at 5V V<sub>CC</sub>
- Bushold data inputs eliminate the need for external pull-up resistors to hold unused inputs (74LVTH574), also available without bushold feature (74LVT574)
- Live insertion/extraction permitted
- Power Up/Down high impedance provides glitch-free bus loading
- Outputs source/sink –32mA/+64mA
- Functionally compatible with the 74 series 574
- Latch-up performance exceeds 500mA
- ESD performance:
  - Human-body model > 2000V
  - Machine model > 200V

**Ordering Information** 

- Charged-device model > 1000V

# **General Description**

The LVT574 and LVTH574 are high-speed, low-power octal D-type flip-flop featuring separate D-type inputs for each flip-flop and 3-STATE outputs for bus-oriented applications. A buffered Clock (CP) and Output Enable  $\overline{(OE)}$  are common to all flip-flops.

The LVTH574 data inputs include bushold, eliminating the need for external pull-up resistors to hold unused inputs.

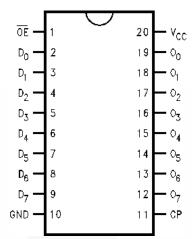
These octal flip-flops are designed for low-voltage (3.3V)  $V_{CC}$  applications, but with the capability to provide a TTL interface to a 5V environment. The LVT574 and LVTH574 are fabricated with an advanced BiCMOS technology to achieve high speed operation similar to 5V ABT while maintaining a low power dissipation.

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Order Number	Package Number	Package Description			
74LVT574WM	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide			
74LVT574SJ	M20D	20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide			
74LVT574MSA	MSA20	20-Lead Shrink Small Outline Package (SSOP), JEDEC MO-150, 5.3mm Wide			
74LVT574MTC	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide			
74LVTH574WM	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide			
74LVTH574SJ	M20D	20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide			
74LVTH574MSA	MSA20	20-Lead Shrink Small Outline Package (SSOP), JEDEC MO-150, 5.3mm Wide			
74LVTH574MTC	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide			

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

All packages are lead free per JEDEC: J-STD-020B standard.

# **Connection Diagram**

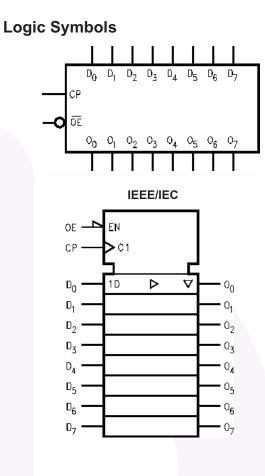


# **Pin Description**

Pin Names	Description
D <sub>0</sub> –D <sub>7</sub> Data Inputs	
CP Clock Pulse Input	
ŌĒ	3-STATE Output Enable Input
O <sub>0</sub> –O <sub>7</sub>	3-STATE Outputs

# **Functional Description**

The LVT574 and LVTH574 consist of eight edgetriggered flip-flops with individual D-type inputs and 3-STATE true outputs. The buffered clock and buffered Output Enable are common to all flip-flops. The eight flip-flops will store the state of their individual D-type inputs that meet the setup and hold time requirements on the LOW-to-HIGH Clock (CP) transition. With the Output Enable ( $\overline{OE}$ ) LOW, the contents of the eight flip-flops are available at the outputs. When the  $\overline{OE}$  is HIGH, the outputs go to the high impedance state. Operation of the  $\overline{OE}$  input does not affect the state of the flip-flops.



# Truth Table

	Outputs		
D <sub>n</sub>	СР	OE	O <sub>n</sub>
Н	~	L	Н
L	~	L	L
Х	L	L	Oo
Х	Х	Н	Z

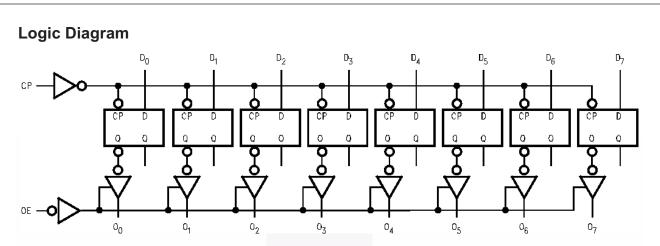
H = HIGH Voltage Level

L = LOW Voltage Level

X = Immaterial

- Z = High Impedance
- ✓ = LOW-to-HIGH Transition

O<sub>o</sub> = Previous O<sub>o</sub> before HIGH to LOW of CP



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

# **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating	
V <sub>CC</sub>	Supply Voltage	-0.5V to +4.6V	
VI	DC Input Voltage	-0.5V to +7.0V	
Vo	DC Output Voltage		
	Output in 3-STATE	-0.5V to +7.0V	
	Output in HIGH or LOW State <sup>(1)</sup>	-0.5V to +7.0V	
I <sub>IK</sub>	DC Input Diode Current, V <sub>I</sub> < GND		
I <sub>ОК</sub>	DC Output Diode Current, V <sub>O</sub> < GND	–50mA	
Ι <sub>Ο</sub>	DC Output Current, V <sub>O</sub> > V <sub>CC</sub>		
	Output at HIGH State	64mA	
	Output at LOW State	128mA	
I <sub>CC</sub>	DC Supply Current per Supply Pin		
I <sub>GND</sub>	DC Ground Current per Ground Pin ±1		
T <sub>STG</sub>	Storage Temperature	–65°C to +150°C	

Note:

1. I<sub>O</sub> Absolute Maximum Rating must be observed.

# **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter		Max	Units
V <sub>CC</sub>	Supply Voltage	2.7	3.6	V
VI	Input Voltage	0	5.5	V
I <sub>OH</sub>	HIGH-Level Output Current		-32	mA
I <sub>OL</sub>	LOW-Level Output Current		64	mA
T <sub>A</sub>	T <sub>A</sub> Free-Air Operating Temperature		85	°C
$\Delta t / \Delta V$	Input Edge Rate, $V_{IN} = 0.8V - 2.0V$ , $V_{CC} = 3.0V$	0	10	ns/V

					$T_A = -4$	40°C to +	85°C		
Symbol	Paran	neter	V <sub>CC</sub> (V)	Conditions	Min.	Typ. <sup>(2)</sup>	Max.	Units	
V <sub>IK</sub>	Input Clamp Diode Voltage		2.7	I <sub>I</sub> = -18mA			-1.2	V	
V <sub>IH</sub>	Input HIGH Vol	Itage	2.7–3.6	$V_0 \le 0.1V$ or	2.0			V	
V <sub>IL</sub>	Input LOW Voltage		2.7–3.6	$V_{O} \ge V_{CC} - 0.1V$			0.8	V	
V <sub>OH</sub>	Output HIGH V	/oltage	2.7–3.6	I <sub>OH</sub> = -100µA	V <sub>CC</sub> -0.2			V	
			2.7	I <sub>OH</sub> = -8mA	2.4			1	
			3.0	$I_{OH} = -32mA$	2.0			1	
V <sub>OL</sub>	Output LOW Vo	oltage	2.7	$I_{OL} = 100 \mu A$			0.2	V	
				$I_{OL} = 24 \text{mA}$			0.5	1	
			3.0	$I_{OL} = 16 \text{mA}$			0.4	1	
				$I_{OL} = 32mA$			0.5	1	
				$I_{OL} = 64 \text{mA}$			0.55	1	
I <sub>I(HOLD)</sub> <sup>(3)</sup>	Bushold Input I	Minimum	3.0	$V_{I} = 0.8V$	75			μA	
Drive	Drive			V <sub>I</sub> = 2.0V	-75			1	
I <sub>I(OD)</sub> <sup>(3)</sup> Bushold Input Current to Cha	Over-Drive	3.0	(4)	500			μA		
	Current to Cha	irrent to Change State		(5)	-500			1	
Input Current			3.6	$V_{I} = 5.5V$			10	μA	
		Control Pins Data Pins	3.6	$V_I = 0V \text{ or } V_{CC}$			±1	1	
			3.6	$V_{I} = 0V$			-5	1	
				$V_I = V_{CC}$			1	1	
I <sub>OFF</sub>	Power Off Leal	kage Current	0	$0V \le V_I \text{ or } V_O \le 5.5V$			±100	μA	
I <sub>PU/PD</sub>	Power up/dowr Output Current		0–1.5	$V_0 = 0.5V$ to 3.0V, $V_1 = GND$ or $V_{CC}$			±100	μA	
I <sub>OZL</sub>	3-STATE Outpu Current	ut Leakage	3.6	$V_{O} = 0.5V$			-5	μA	
I <sub>OZH</sub>	3-STATE Outpu Current	ut Leakage	3.6	V <sub>O</sub> = 3.0V			5	μΑ	
I <sub>OZH</sub> +	3-STATE Output Leakage Current		3.6	$V_{CC} < V_O \le 5.5V$			10	μA	
I <sub>CCH</sub>	Power Supply Current		3.6	Outputs HIGH			0.19	mA	
I <sub>CCL</sub>	Power Supply Current		3.6	Outputs LOW			5	mA	
I <sub>CCZ</sub>	Power Supply Current		3.6	Outputs Disabled			0.19	mA	
I <sub>CCZ</sub> +	Power Supply Current		3.6	$V_{CC} \le V_O \le 5.5V$ , Outputs Disabled			0.19	mA	
$\Delta I_{CC}$	Increase in Pov Current <sup>(6)</sup>	wer Supply	3.6	One Input at $V_{CC} - 0.6V$ , Other Inputs at $V_{CC}$ or GND			0.2	mA	

# 74LVT574, 74LVTH574 — Low Voltage Octal D-Type Flip-Flop with 3-STATE Outputs

### Notes:

2. All typical values are at  $V_{CC}$  = 3.3V,  $T_{A}$  = 25°C.

**DC Electrical Characteristics** 

3. Applies to bushold versions only (74LVTH574).

4. An external driver must source at least the specified current to switch from LOW-to-HIGH.

5. An external driver must sink at least the specified current to switch from HIGH-to-LOW.

6. This is the increase in supply current for each input that is at the specified voltage level rather than  $V_{CC}$  or GND.

# Dynamic Switching Characteristics<sup>(7)</sup>

			Conditions	1	A = 25°	C	
Symbol	Parameter	V <sub>CC</sub> (V)	$C_L = 50 pF, R_L = 500 \Omega$	Min.	Тур.	Max.	Units
V <sub>OLP</sub>	Quiet Output Maximum Dynamic V <sub>OL</sub>	3.3	(8)		0.8		V
V <sub>OLV</sub>	Quiet Output Minimum Dynamic V <sub>OL</sub>	3.3	(8)		-0.8		V

Notes:

7. Characterized in SOIC package. Guaranteed parameter, but not tested.

8. Max number of outputs defined as (n). n-1 data inputs are driven 0V to 3V. Output under test held LOW.

# **AC Electrical Characteristics**

		$\label{eq:TA} \begin{array}{l} \textbf{T}_{\textbf{A}} = -40^{\circ} \textbf{C} \ \mbox{to} \ +85^{\circ} \textbf{C} \\ \textbf{C}_{\textbf{L}} = 50 p \textbf{F}, \ \textbf{R}_{\textbf{L}} = 500 \Omega \end{array}$					
		V <sub>CC</sub>	= 3.3V ±	0.3V	V <sub>CC</sub> =	= <b>2.7V</b>	
Symbol	Parameter	Min.	Typ. <sup>(9)</sup>	Max.	Min.	Max.	Units
f <sub>MAX</sub>	Maximum Clock Frequency	150			150		MHz
t <sub>PHL</sub>	Propagation Delay, CP to O <sub>n</sub>	1.8		4.6	1.8	5.3	ns
t <sub>PLH</sub>	1	1.8		4.5	1.8	5.3	
t <sub>PZL</sub>	Output Enable Time	1.5		5.2	1.5	6.1	ns
t <sub>PZH</sub>	1	1.5		4.8	1.5	5.9	
t <sub>PLZ</sub>	Output Disable Time	2.0		4.4	2.0	4.4	ns
t <sub>PHZ</sub>		2.0		4.8	2.0	5.1	
t <sub>S</sub>	Setup Time	2.0			2.4		ns
t <sub>H</sub>	Hold Time	0.3			0.0		ns
t <sub>W</sub>	Pulse Width	3.3			3.3		ns
t <sub>OSHL</sub> , t <sub>OSLH</sub>	Output to Output Skew <sup>(10)</sup>			1.0		1.0	ns

### Notes:

9. All typical values are at  $V_{CC} = 3.3V$ ,  $T_A = 25^{\circ}C$ .

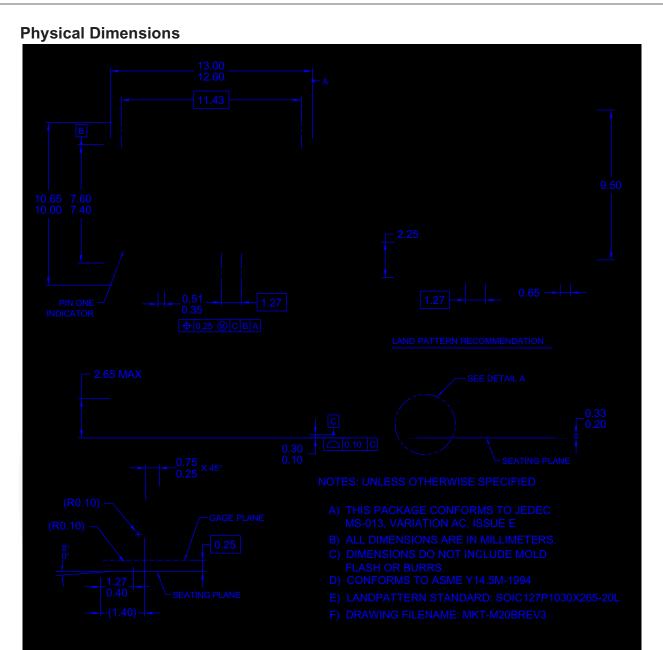
 Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t<sub>OSHL</sub>) or LOW-to-HIGH (t<sub>OSLH</sub>).

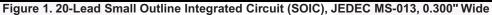
# Capacitance<sup>(11)</sup>

Symbol	Parameter	Conditions	Typical	Units
C <sub>IN</sub>	Input Capacitance	$V_{CC} = Open, V_I = 0V \text{ or } V_{CC}$	4	pF
C <sub>OUT</sub>	Output Capacitance	$V_{CC}$ = 3.0V, $V_{O}$ = 0V or $V_{CC}$	6	pF

### Note:

11. Capacitance is measured at frequency f = 1MHz, per MIL-STD-883, Method 3012.

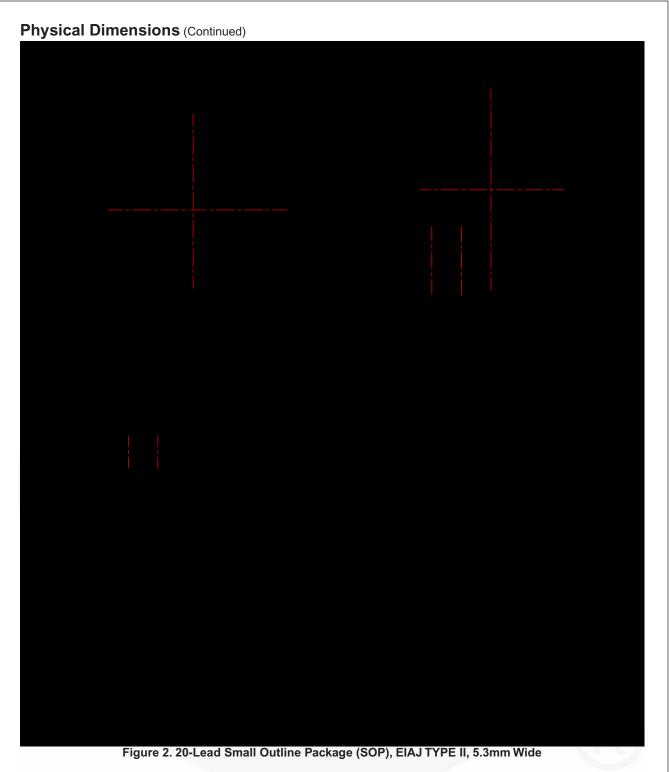




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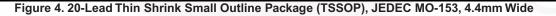
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74LVT574, 74LVTH574 — Low Voltage Octal D-Type Flip-Flop with 3-STATE Outputs

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Physical Dimensions (Continued)



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